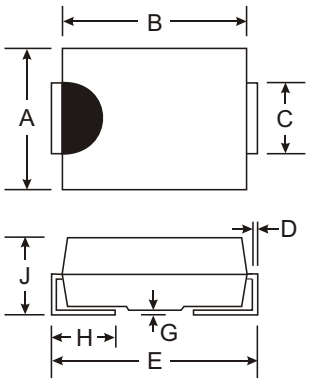
B220/A - B260/A

2.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automatic Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 50A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- High Temperature Soldering: 260°C/10 Second at Terminal
- **Available in Lead Free Finish/RoHS Compliant Version (Note 3)**



Dim	SMA		SMB	
	Min	Max	Min	Max
A	2.29	2.92	3.30	3.94
B	4.00	4.60	4.06	4.57
C	1.27	1.63	1.96	2.21
D	0.15	0.31	0.15	0.31
E	4.80	5.59	5.00	5.59
G	0.10	0.20	0.10	0.20
H	0.76	1.52	0.76	1.52
J	2.01	2.30	2.00	2.40
All Dimensions in mm				

No Suffix Designates SMB Package
"A" Suffix Designates SMA Package

Mechanical Data

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solder Plated Terminal - Solderable per MIL-STD-202, Method 208
- Also Available in Lead Free Plating (Matte Tin Finish). Please See Ordering Information, Note 5, on Page 2
- Polarity: Cathode Band or Cathode Notch
- Marking: Type Number
- Approximate Weight: SMA 0.064 grams
  SMB 0.093 grams

Maximum Ratings and Electrical Characteristics @ T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	B220/A	B230/A	B240/A	B250/A	B260/A	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	30	40	50	60	V
RMS Reverse Voltage	$V_{R(RMS)}$	14	21	28	35	42	V
Average Rectified Output Current @ T_T = 100°C	I_O	2.0					A
Non-Repetitive Peak Forward Surge Current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	50					A
Forward Voltage @ I_F = 2.0A	V_{FM}	0.50			0.70		V
Peak Reverse Current @ T_A = 25°C at Rated DC Blocking Voltage @ T_A = 100°C	I_{RM}	0.5 20					mA
Typical Total Capacitance (Note 2)	C_T	200					pF
Typical Thermal Resistance, Junction to Terminal	$R_{\theta JT}$	20					°C/W
Typical Thermal Resistance, Junction to Ambient (Note 1)	$R_{\theta JA}$	25					°C/W
Operating and Storage Temperature Range	T_j, T_{STG}	-65 to +150					°C

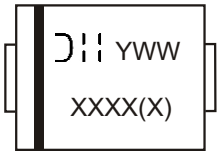
Notes: 1. Thermal Resistance: Junction to terminal, unit mounted on PC board with 5.0 mm^2 (0.013 mm thick) copper pad as heat sink.
2. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.
3. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see *EU Directive Annex Notes 5 and 7.*

Ordering Information (Note 4 & 5)

Device*	Packaging	Shipping
B2xxA-13	SMA	5000/Tape & Reel
B2xx-13	SMB	3000/Tape & Reel

* x = Device type, e.g. B260A-13 (SMA package); B240-13 (SMB package).

Notes:
4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.
5. For Lead Free Finish/RoHS Compliant version part number, please add "-F" suffix to the part number above. Example: B250-13-F.



XXXX = Product type marking code, ex: B220A (SMA package)
XXXX = Product type marking code, ex: B230 (SMB package)
= Manufacturers' code marking
YWW = Date code marking
Y = Last digit of year ex: 2 for 2002
WW = Week code 01 to 52

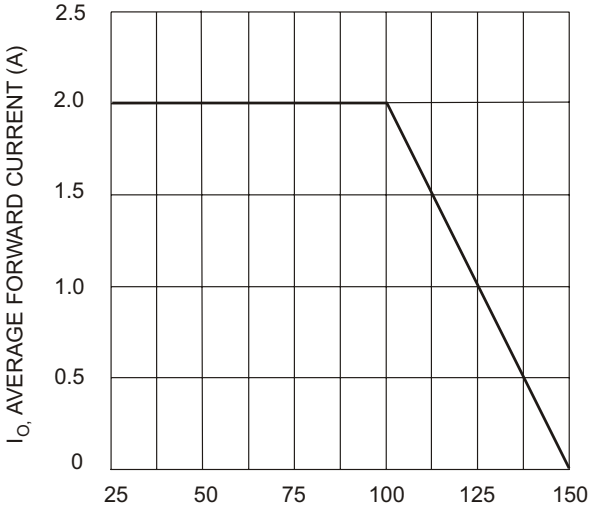


Fig. 1 Forward Current Derating Curve

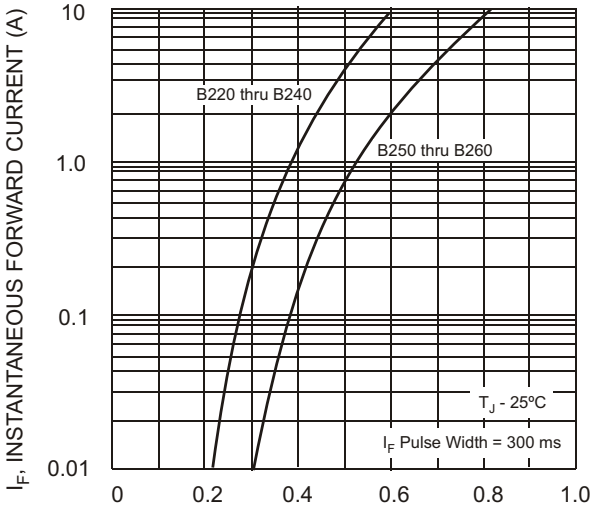


Fig. 2 Typical Forward Characteristics

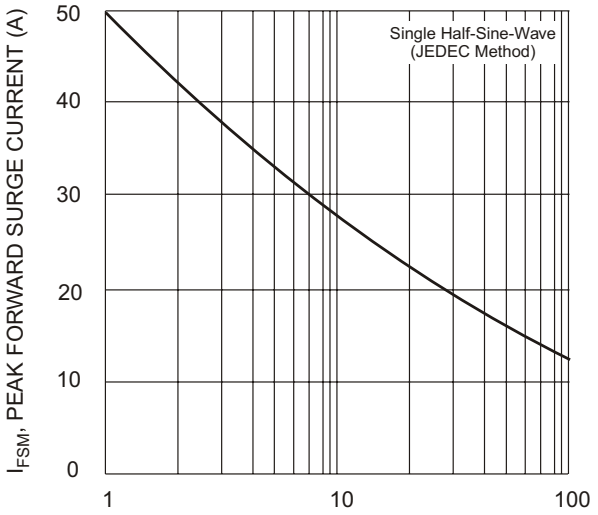


Fig. 3 Max Non-Repetitive Peak Forward Surge Current

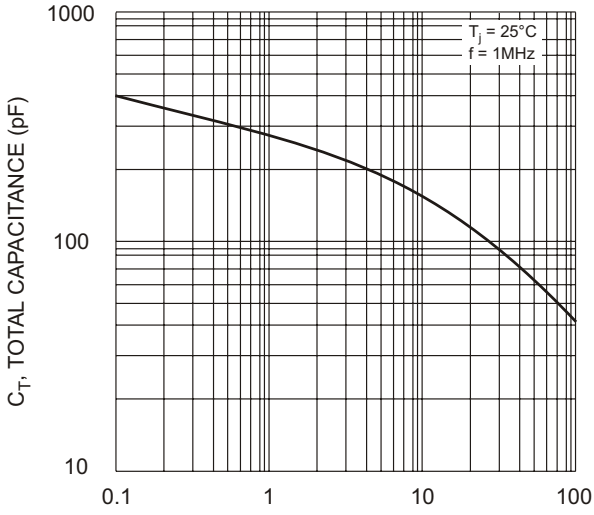


Fig. 4 Typical Total Capacitance

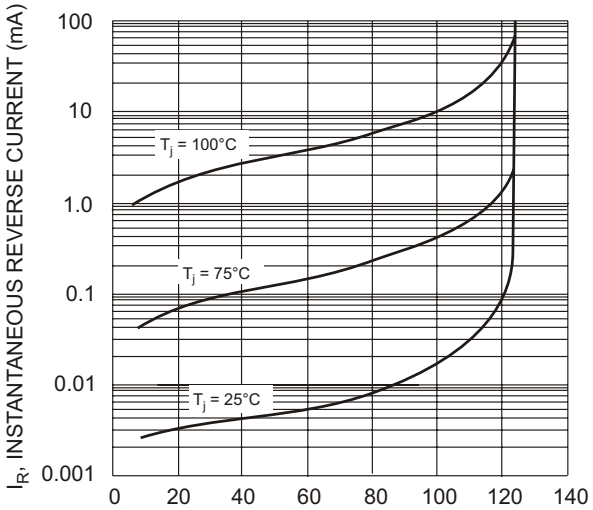


Fig. 5 Typical Reverse Characteristics